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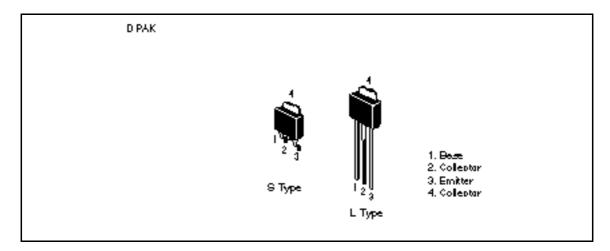
Silicon NPN Epitaxial Planar

HITACHI

Application

Low frequency power amplifier

Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Rating	Unit
Collector to base voltage	V_{CBO}	150	V
Collector to emitter voltage	V _{CEO}	60	V
Emitter to base voltage	V _{EBO}	5	V
Collector current	I _c	2	A
Collector peak current	I _{C(peak)}	2.5	A
Collector power dissipation	P _C *1	18	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. Value at $T_c = 25$ °C.

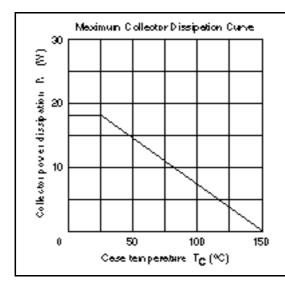


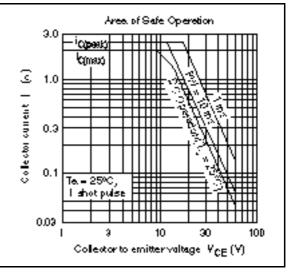
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Electrical Characteristics ($Ta = 25^{\circ}C$)

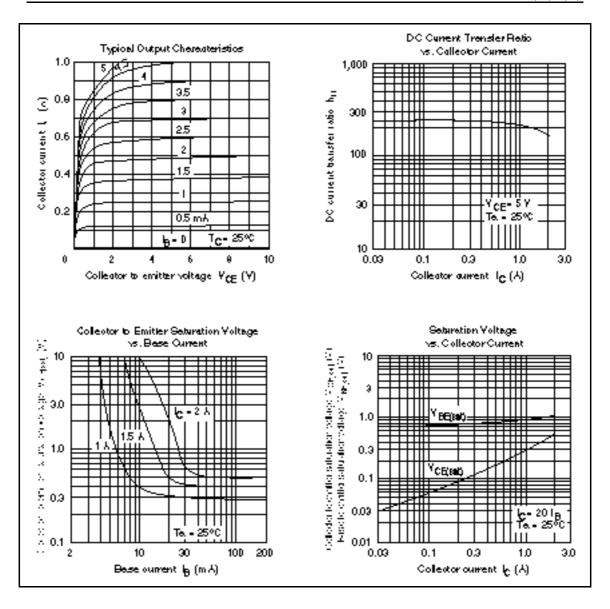
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	150	_	_	V	$I_C = 1 \text{ mA}, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	60	_	_	V	$I_C = 10 \text{ mA}, R_{BE} =$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	_	_	V	$I_{E} = 1 \text{ mA}, I_{C} = 0$
Collector cutoff current	I _{CBO}	_	_	10	μΑ	$V_{CB} = 100 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE}	150	_	_		$V_{CE} = 5 \text{ V}, I_{C} = 1.5 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	0.8	V	$I_{\rm C} = 1.5 \text{ A}, I_{\rm B} = 0.05 \text{ A}^{*1}$
Base to emitter saturation voltage	$V_{BE(sat)}$	_	_	1.3	V	$I_{\rm C} = 1.5 \text{ A}, I_{\rm B} = 0.05 \text{ A}^{*1}$
Fall time	t _f	_	_	0.6	μs	$I_{\rm C} = 1.5 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 50 \text{ mA}$

Note: 1. Pulse test.





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